Application No.: 10/672,833

Office Action Dated: November 14, 2008

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1. (Previously Presented) A circuit pad for reducing discomfort caused by a

magnetic stimulation device, comprising:

at least one conductor located peripheral to a magnetic stimulation

device, wherein the conductor is adapted to reduce stimulation induced by the magnetic

stimulation device.

2. (Original) The circuit pad of claim 1, further comprising a circuit in

communication with the conductor.

3. (Original) The circuit pad of claim 1, further comprising reducing stimulation

by the magnetic stimulation device at a predetermined location.

4. (Original) The circuit pad of claim 3, wherein the predetermined location is

determined relative to a treatment area.

5. (Original) The circuit pad of claim 4, wherein the treatment area is a portion

of a brain and wherein the predetermined location is a cutaneous-proximate area relative to

the treatment area.

6. (Original) The circuit pad of claim 1, further comprising a connector in

communication with the conductor, wherein the connector provides an interface with the

magnetic stimulation device.

7. (Original) The circuit pad of claim 1, further comprising a disposal

mechanism that renders the circuit pad inoperable.

8. (Original) The circuit pad of claim 7, wherein the disposal mechanism acts

automatically upon removal from a patient.

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9. (Original) The circuit pad of claim 7, wherein the disposal mechanism is

activated by a user of the circuit pad.

10. (Original) The circuit pad of claim 7, wherein the disposal mechanism

changes the physical and electrical properties of the conductor.

11. (Original) The circuit pad of claim 7, wherein the disposal mechanism

disconnects communication between the conductor and the circuit.

12. (Original) The circuit pad of claim 7, wherein the disposal mechanism is

activated after a predetermined number of uses.

13. (Original) The circuit pad of claim 7, wherein the disposal mechanism

permits a certain patient to use the circuit pad for a predetermined period.

14. (Original) The circuit pad of claim 13, wherein the predetermined period is a

function of a number of uses.

15. (Original) The circuit pad of claim 13, wherein the predetermined period is a

function of a number of a duration of time.

16. (Original) The circuit pad of claim 7, wherein the disposal mechanism

destroys the circuit pad upon removal from the patient.

17. (Original) The circuit pad of claim 7, wherein the disposal mechanism is

constructed of materials that cannot be sanitized.

18. (Original) The circuit pad of claim 7, wherein the circuit pad is adapted to

become inoperable when contacted with cleaning materials.

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19. (Original) The circuit pad of claim 7, wherein the circuit pad is constructed of

materials that disintegrate when in contact with cleaning solutions.

20. (Original) The circuit pad of claim 1, wherein the circuit pad is adapted to be

attached to the patient.

21. (Original) The circuit pad of claim 1, wherein the circuit pad is adapted to be

attached to the magnetic stimulation device.

22. (Original) The circuit pad of claim 1, wherein the circuit pad comprises an

adhesive.

23. (Original) The circuit pad of claim 1, wherein the conductor is a flat metallic

device.

24. (Original) The circuit pad of claim 23, wherein the conductor is located

between two surfaces of the circuit pad.

25. (Original) The circuit pad of claim 1, wherein the conductor has an area of in

the range of 1 centimeter² to 40 centimeter².

26. (Original) The circuit pad of claim 1, wherein the reducing of the stimulation

occurs by reducing magnetic flux density created by the magnetic stimulation device.

27. (Original) The circuit pad of claim 1, wherein the reducing of the stimulation

occurs by superimposing a magnetic field created by the conductors on the circuit pad and a

magnetic field created by the magnetic stimulation device.

28. (Original) The circuit pad of claim 1, wherein the conductor is provided

electrical energy substantially simultaneously with electrical energy provided to the magnetic

stimulation device.

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29. (Original) The circuit pad of claim 28, wherein the electrical energy provided

to the conductor and the electrical energy provided to the magnetic stimulation device are of

opposite polarity.

30. (Original) The circuit pad of claim 28, wherein the electrical energy provided

to the conductor is a current that is derived from a voltage provided to the magnetic

stimulation device.

31. (Original) The circuit pad of claim 1, wherein the circuit pad is adapted to

receive a conductive gel that facilitates communication between the circuit pad and a

treatment area.

32. (Original) The circuit pad of claim 31, wherein the conductive gel is received

by an absorbent portion of the circuit pad.

33. (Original) The circuit pad of claim 32, wherein the absorbent portion of the

circuit pad comprises a sponge material.

34. (Original) The circuit pad of claim 31, wherein the conductive gel is located

within a plastic material on the circuit pad.

35. (Original) The circuit pad of claim 1, wherein the conductor is placed

substantially orthogonal to an electric field vector created by the magnetic stimulation device.

36. (Original) The circuit pad of claim 1, wherein the conductor has rounded

edges.

37. (Original) The circuit pad of claim 1, wherein the conductor has a high aspect

ratio.

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38. (Original) The circuit pad of claim 1, wherein a relatively longer dimension of the conductor is placed along a similar direction as an electric field vector induced by the magnetic stimulation device.

- 39. (Original) The circuit pad of claim 1, wherein the conductor is arc-shaped.
- 40. (Original) The circuit pad of claim 1, further comprising insulating material for preventing undesired electrical conduction with the circuit pad.
- 41. (Original) The circuit pad of claim 1, wherein the circuit pad is constructed of a flexible material.
- 42. (Previously Presented) The circuit pad of claim 1, wherein the circuit pad is constructed, at least in part, by materials including at least one of the following: plastic, mylar, or polyester.
- 43. (Original) The circuit pad of claim 1, wherein the magnetic stimulation device comprises a magnetic core that saturates at 0.5 Tesla or greater.
- 44. (Original) A method for treating a patient using transcutaneous magnetic stimulation, comprising:

directing a magnetic field created by a magnetic stimulation device to a treatment area on the patient;

applying a flexible circuit pad, wherein the flexible circuit pad comprises at least one conductor adapted to reduce stimulation induced by the magnetic stimulation device; and

treating the patient with the magnetic field.

45. (Original) The method of claim 44, wherein the magnetic stimulation device comprises a magnetic core that saturates at 0.5 Tesla or greater.

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46. (Original) The method of claim 44, further comprising applying the flexible

circuit pad to the treatment area.

47. (Original) The method of claim 44, further comprising applying the flexible

circuit pad to the magnetic stimulation device.

48. (Original) The method of claim 44, wherein the magnetic stimulation device

comprises a magnetic core with a non-toroidal geometry.

49. (Original) The method of claim 44, wherein the conductor reduces stimulation

of a cutaneous-proximate area on the patient.

50. (Original) The method of claim 44, further comprising locating the magnetic

stimulation device to the treatment area on the patient.

51. (Original) The method of claim 44, further comprising applying the flexible

circuit pad to the patient.

52. (Original) The method of claim 44, further comprising applying a conductive

gel material between the flexible circuit pad and the patient.

53. (Original) The method of claim 44, further comprising insulating the flexible

circuit pad from undesired electrical conduction.

54. (Original) The method of claim 44, further comprising activating a disposal

mechanism that renders the flexible circuit pad inoperable.

55. (Original) The method of claim 54, wherein the activating of the disposal

mechanism occurs after the patient is treated with the magnetic field.

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56. (Original) The method of claim 54, further wherein the activating of the disposal mechanism occurs automatically upon removal from a patient.

57. (Original) The method of claim 54, wherein activating of the disposal

mechanism is conducted by a user of the flexible circuit pad.

58. (Original) The method of claim 54, wherein the activating of the disposal

mechanism comprises changing the physical and electrical properties of the conductor.

59. (Original) The method of claim 54, wherein the activating of the disposal

mechanism comprises disconnecting communication with the flexible circuit pad.

60. (Original) The method of claim 54, wherein the activating of the disposal

mechanism occurs after a predetermined number of uses.

61. (Original) The method of claim 44, further comprising adapting the flexible

circuit pad to be attached to the patient.

62. (Original) The method of claim 44, further comprising adapting the flexible

circuit pad to be attached to the magnetic stimulation device.

63. (Original) The method of claim 44, further comprising applying an adhesive

to the flexible circuit pad.

64. (Original) The method of claim 44, further comprising providing a conductive

gel that facilitates communication with the flexible circuit pad.

65. (Original) The method of claim 44, further comprising injecting a conductive

gel that facilitates communication with the flexible circuit pad.

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66. (Previously Presented) The method of claim 44, wherein the circuit pad is constructed, at least in part, by materials including at least one of the following: plastic, mylar, or polyester.

67. (Original) A circuit pad for reducing discomfort caused by a magnetic stimulation device, comprising:

a ferrite material located peripheral to the magnetic stimulation device, wherein the ferrite material is adapted to reduce stimulation induced by the magnetic stimulation device.

- 68. (Original) The circuit pad of claim 67, further comprising a circuit in communication with the ferrite material.
- 69. (Original) The circuit pad of claim 67, wherein the ferrite material is located between two surfaces of the circuit pad.